- Each Device Drives 12 Lines
- 60-V Output Voltage Swing Capability
- 25-mA Output Source Current Capability
- High-Speed Serially-Shifted Data Input
- TTL-Compatible Inputs
- Latches on All Driver Outputs

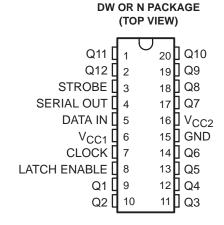
#### description

The SN65512C and SN75512C are monolithic BIDFET<sup>†</sup> integrated circuits designed to drive a dot matrix or segmented vacuum fluorescent display.

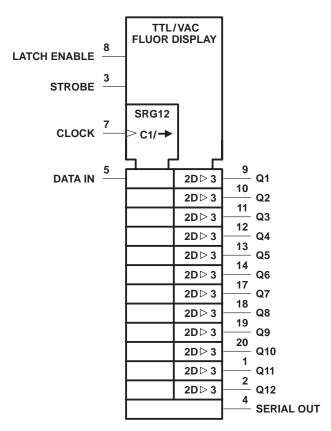
All device inputs are diode-clamped pnp inputs and assume a high logic level when open circuited. The nominal input threshold is 1.5 V. Outputs are totem-pole structures formed by an npn emitter follower and double-diffused MOS (DMOS) transistors.

The device consists of a 12-bit shift register, 12 latches, and 12 output AND gates. Serial data is entered into the shift register on the low-to-high transition of CLOCK. When high, LATCH ENABLE transfers the shift register contents to the outputs of the 12 latches. The active-low STROBE input enables all Q outputs. Serial data output from the shift register can be used to cascade shift registers. This output is not affected by LATCH ENABLE or STROBE.

The SN65512C is characterized for operation from -40°C to 85°C. The SN75512C is characterized for operation from 0°C to 70°C.



#### logic symbol‡



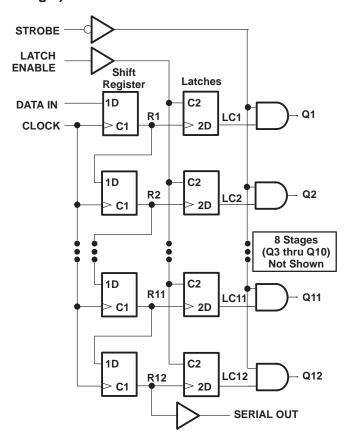
<sup>&</sup>lt;sup>‡</sup>This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

†BIDFET - Bipolar, double-diffused, N-channel and P-channel MOS transistors on same chip. This is a patented process.



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#### logic diagram (positive logic)



**FUNCTION TABLE** 

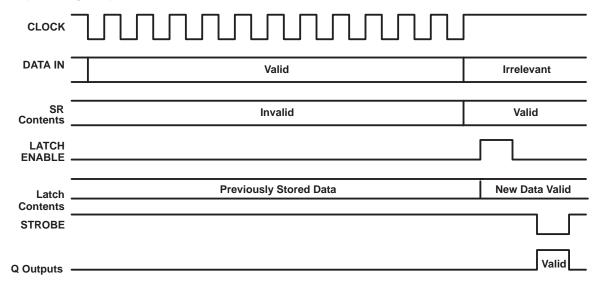
	CONTROL INPUTS			CHIET DEGISTED	LATCHES	OUTPUTS			
FUNCTION	CLOCK LATCH ENABLE		STROBE	SHIFT REGISTER R1 THRU R12	LC1 THRU LC12	SERIAL	Q1 THRU Q12		
Load	↑ No ↑	Х	Х	Load and shift <sup>†</sup> No change	Determined by LATCH ENABLE‡	R12	Determined by STROBE		
Latch	X	L H	Х	As determined above	Stored data New data	R12	Determined by STROBE		
Strobe	х	Х	ΙL	As determined above	Determined by LATCH ENABLE‡	R12	All L LC1 thru LC12, respectively		

H = high level, L = low level, X = irrelevant, ↑ = low-to-high-level transition

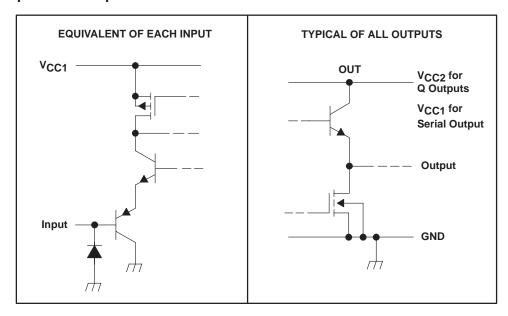
<sup>†</sup>R12 takes on the state of R11, R11 takes on the state of R10, . . . R2 takes on the state of R1, and R1 takes on the state of the data input.

<sup>‡</sup> New data enter the latches while LATCH ENABLE is high. These data are stored while LATCH ENABLE is low.





## schematics of inputs and outputs



## SN65512C, SN75512C VACUUM FLUORESCENT DISPLAY DRIVERS

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC1</sub> (see Note 1)			 
Supply voltage, V <sub>CC2</sub>			 70 V
Input voltage, V <sub>I</sub>			
Continuous total power dissipation			 See Dissipation Rating Table
Operating free-air temperature range:	SN65512C		 –40°C to 85°C
	SN75512C		 0°C to 70°C
Storage temperature range			 –65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) fr	rom case for	10 seconds	 260°C

NOTES: 1. Voltage values are with respect to network GND.

#### **DISSIPATION RATING TABLE**

PACKAGE	$T_{\mbox{\scriptsize A}} \leq 25^{\circ}\mbox{\scriptsize C}$ POWER RATING	DERATING FACTOR ABOVE T <sub>A</sub> = 25°C	T <sub>A</sub> = 70°C POWER RATING	T <sub>A</sub> = 85°C POWER RATING		
DW	1125 mW	9.0 mW/°C	720 mW	585 mW		
N	1150 mW	9.2 mW/°C	736 mW	598 mW		

## recommended operating conditions

		SN65512C		SN75512C						
		MIN	MAX	MIN	MAX	UNIT				
Supply voltage, V <sub>CC1</sub>		5	15	5	15	V				
Supply voltage, V <sub>CC2</sub>		0	60	0	60	V				
High-level input voltage, VIH		2		2		V				
Low-level input voltage, V <sub>IL</sub>			8.0		0.8	V				
High-level output current, IOH			-25		-25	mA				
Low-level output current, IOL	V <sub>CC1</sub> = 5 V		5		5	mA				
Clark framework framework	V <sub>CC1</sub> = 15 V, T <sub>A</sub> = 25°C	0	4	0	4	MHz				
Clock frequency, f <sub>clock</sub>	$V_{CC1} = 5 \text{ V},  T_A = 25^{\circ}\text{C}$	0	1	0	1	MHz				
Dulas duration OLOCK high an law t	V <sub>CC1</sub> = 15 V, T <sub>A</sub> = 25°C	100		100		ns				
Pulse duration, CLOCK high or low, t <sub>W</sub>	$V_{CC1} = 5 \text{ V}, \qquad T_A = 25^{\circ}\text{C}$	500		500		ns				
Sotup time DATA IN before CLOCK 1 (and Figure 1)	$V_{CC1} = 15 \text{ V},  T_A = 25^{\circ}\text{C}$	100		100		ns				
Setup time, DATA IN before CLOCK ↑, t <sub>SU</sub> (see Figure 1)	$V_{CC1} = 5 \text{ V}, \qquad T_A = 25^{\circ}\text{C}$	250		250		ns				
Held time DATA IN offer CLOCK to (eas Figure 4)	V <sub>CC1</sub> = 15 V, T <sub>A</sub> = 25°C	50		50		ns				
Hold time, DATA IN after CLOCK ↑, th (see Figure 1)	$V_{CC1} = 5 \text{ V}, \qquad T_A = 25^{\circ}\text{C}$	250	·	250	250	ns				
Operating free-air temperature, T <sub>A</sub>		-40	85	0	70	°C				

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# electrical characteristics over recommended operating free-air temperature range, $V_{CC2} = 60 \text{ V}$

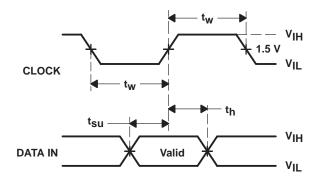
	PARAMETER			TEST CONDITIONS		TYP <sup>†</sup>	MAX	UNIT
VIK	IK Input clamp voltage		$I_{I} = -12 \text{ mA}$				-1.5	V
Vон	High-level output voltage	Q outputs	$I_{OH} = -25 \text{ mA},$	V <sub>CC1</sub> = 5 V	57.5	58		٧
		SERIAL OUT	$I_{OH} = -200 \mu A$ ,	V <sub>CC1</sub> = 5 V	4.5	4.7		
.,	Low-level output voltage	Q outputs	$I_{OL} = 1 \text{ mA},$	V <sub>CC1</sub> = 5 V		2.8	5	V
VOL		SERIAL OUT	$I_{OL} = 200  \mu A$ ,	V <sub>CC1</sub> = 5 V		0.05	0.2	
lΗ	I <sub>IH</sub> High-level input current		V <sub>CC1</sub> = 15 V,	V <sub>I</sub> = 5 V		0.01	10	μΑ
IIL	Low-level input current		V <sub>CC1</sub> = 15 V,	V <sub>I</sub> = 0.8 V		-25	-150	μΑ
	Supply current from V <sub>CC1</sub>		V <sub>CC1</sub> = 15 V	V <sub>I</sub> = 5 V		500	800	μΑ
ICC1				V <sub>I</sub> = 0.8 V		2	6	mA
		15.11	All outputs high		6	12	mA	
ICC2	Supply current from V <sub>CC2</sub>		V <sub>CC1</sub> = 15 V	STROBE at 2 V		100	500	μΑ

<sup>†</sup> All typical values are at V<sub>CC1</sub> = 5 V, T<sub>A</sub> = 25°C.

## switching characteristics, $V_{CC1}$ = 5 V, $V_{CC2}$ = 60 V, $T_A$ = 25°C

	PARAMETER	TEST CONDITIONS	MIN	MAX	UNIT
tDHL	Delay time, high-to-low level output			300	ns
tDLH	Delay time, low-to-high level output	C <sub>I</sub> = 30 pF, See Figure 2		300	ns
tTHL	Transition time, high-to-low level output	CL = 30 pr, See rigule 2		500	ns
<sup>t</sup> TLH	Transition time, low-to-high level output			500	ns

### PARAMETER MEASUREMENT INFORMATION



**Figure 1. Input Timing Voltage Waveforms** 

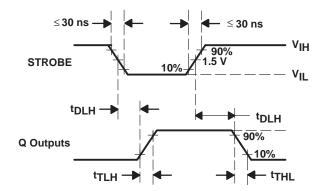


Figure 2. Switching Time Voltage Waveforms

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